
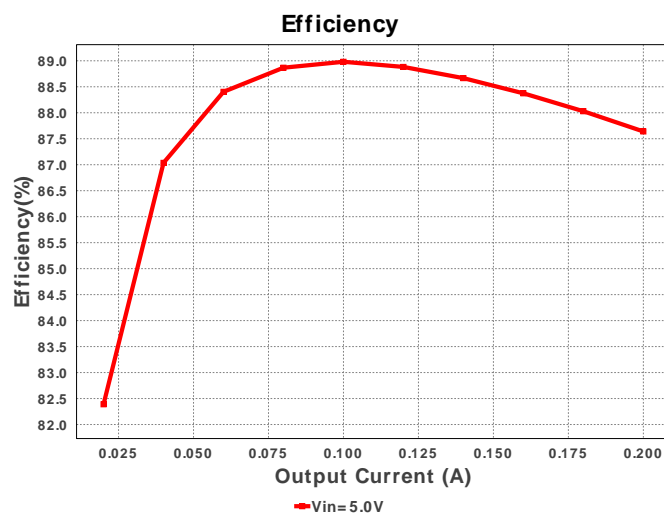
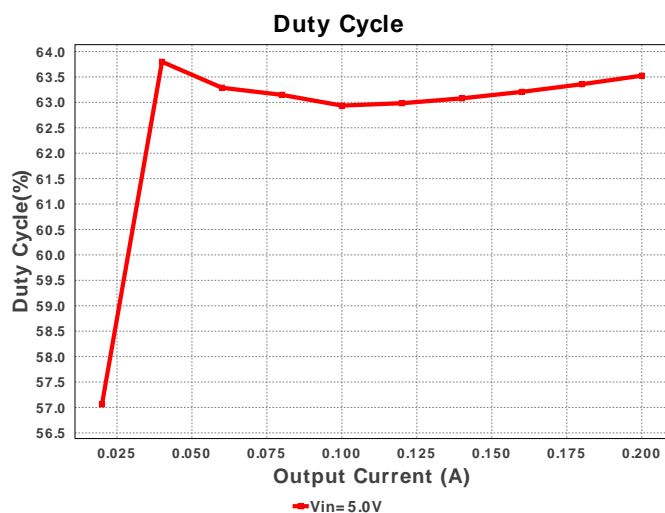
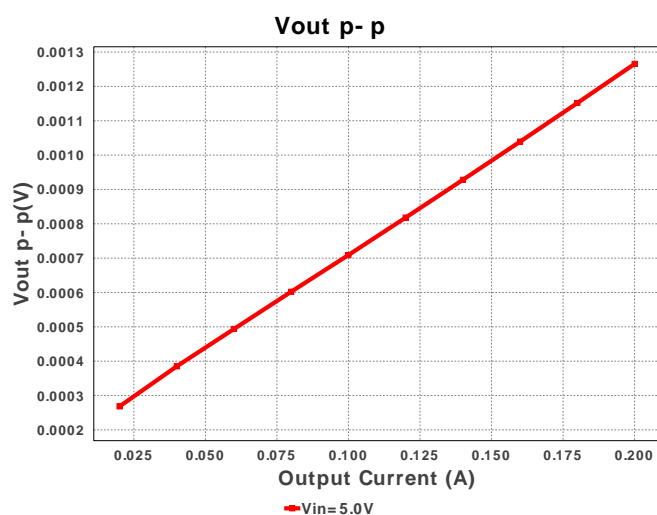
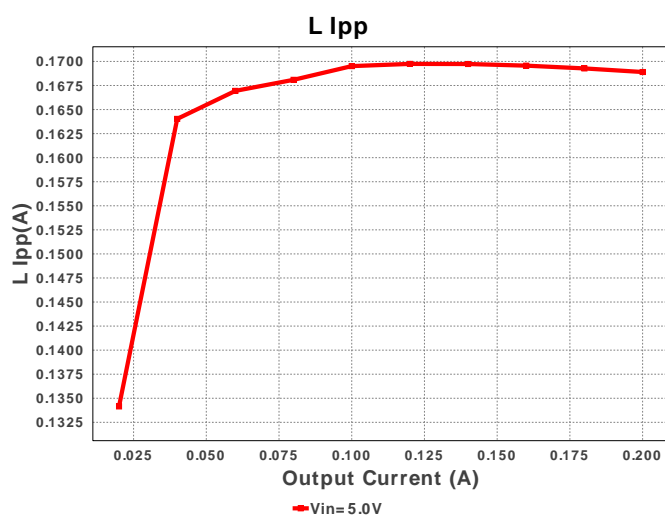
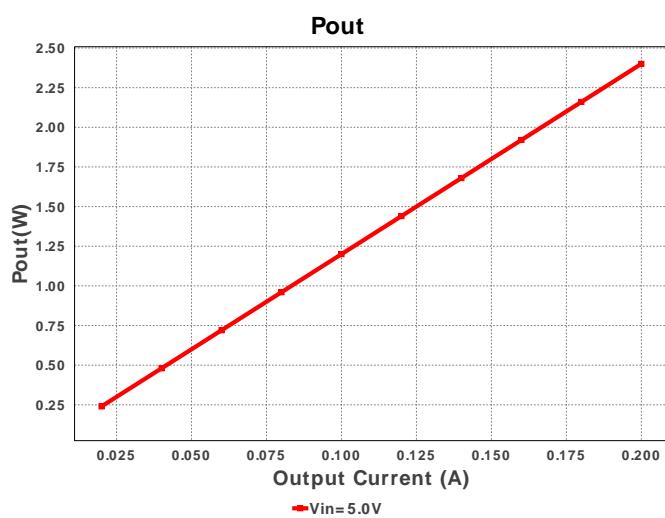
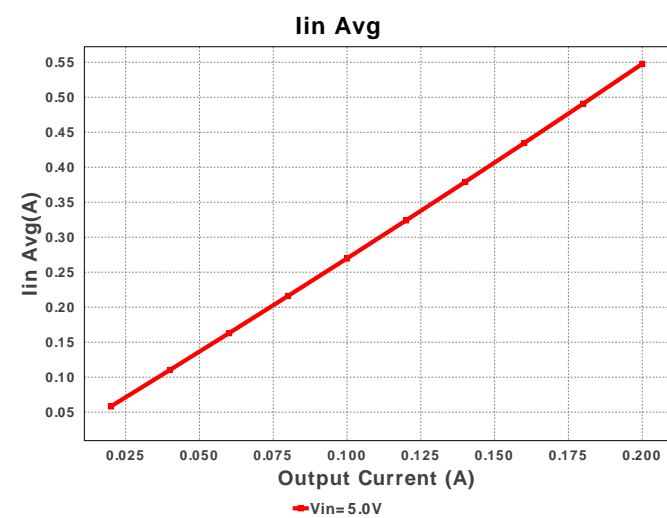
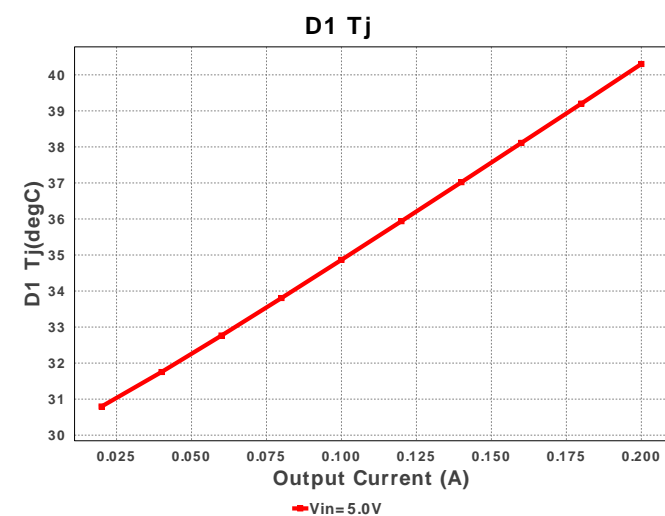
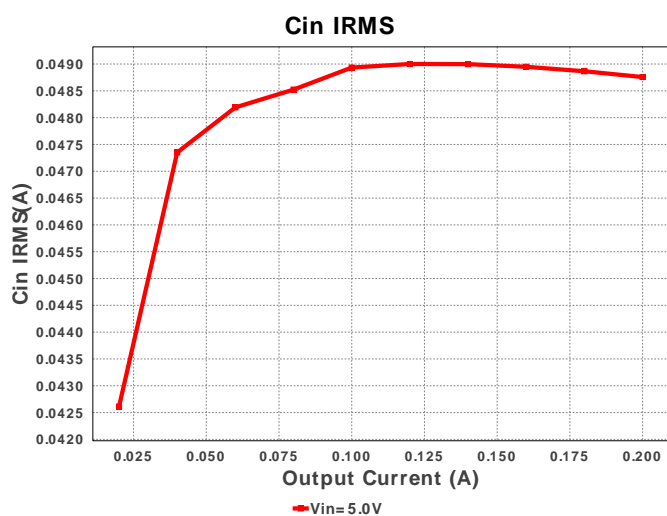
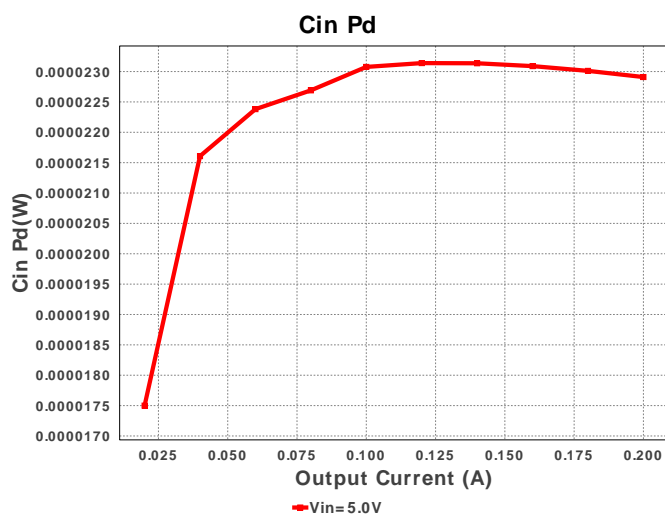
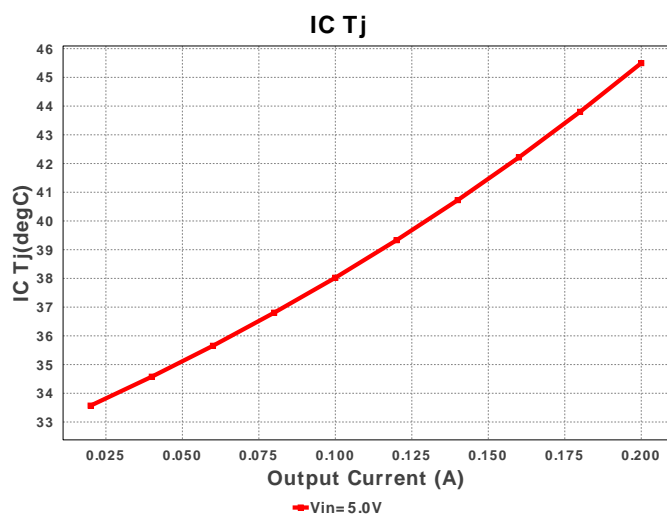


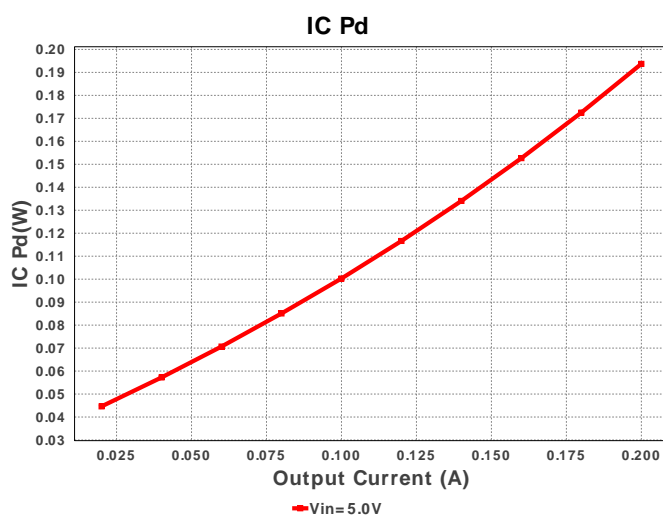
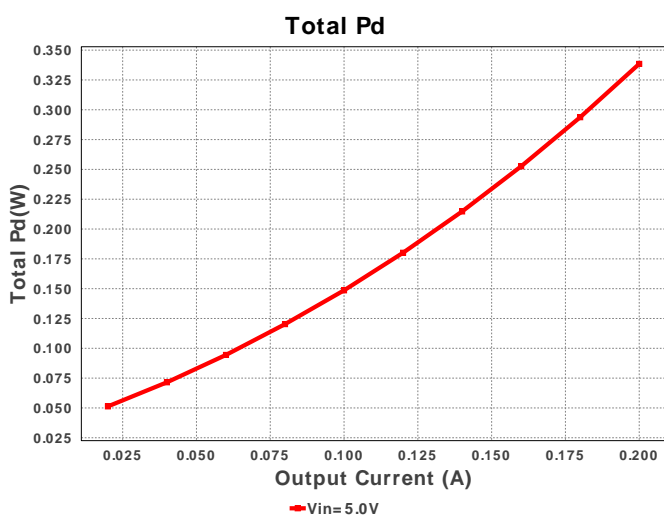
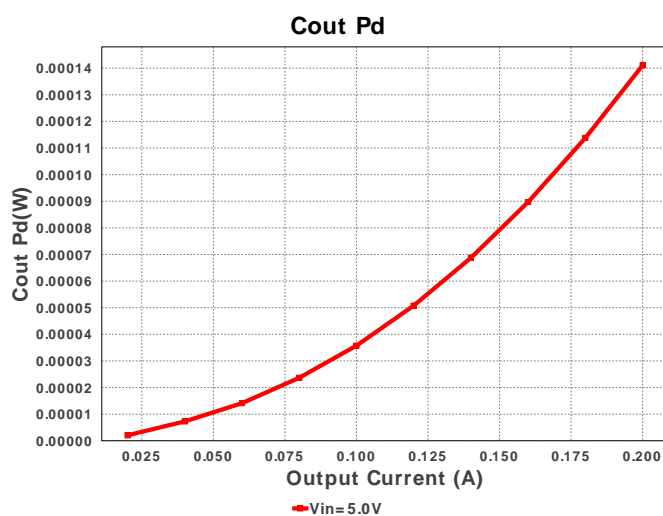
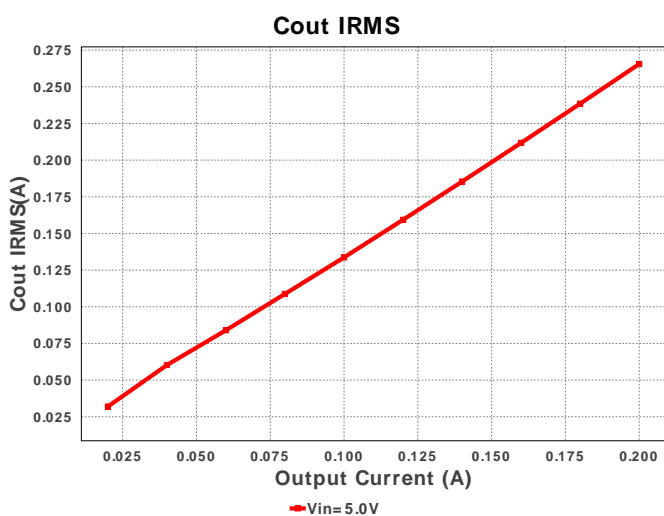
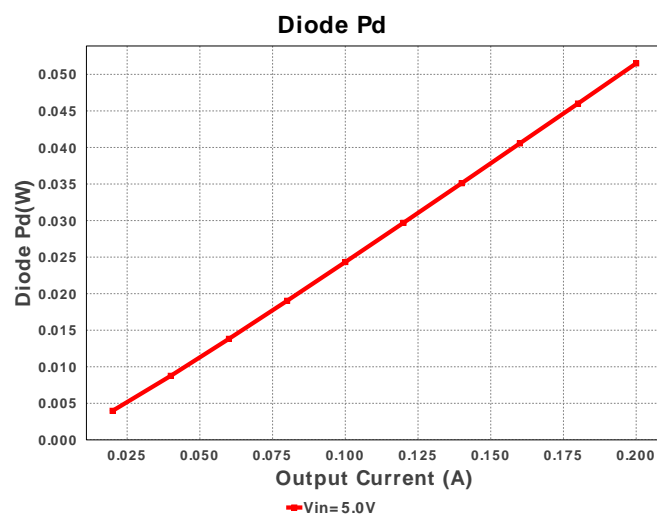
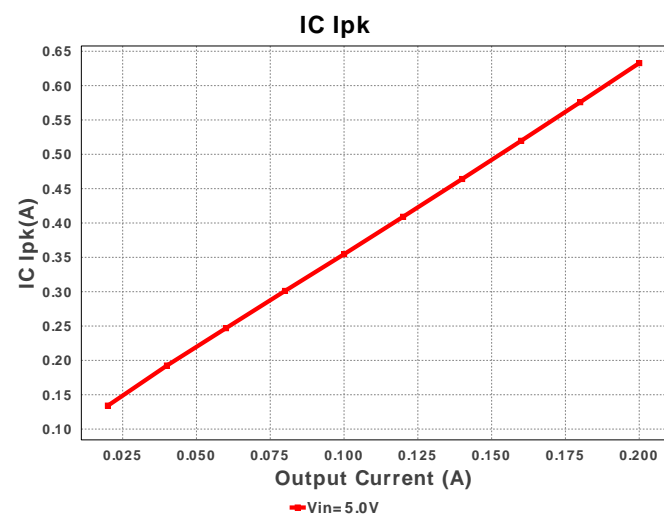


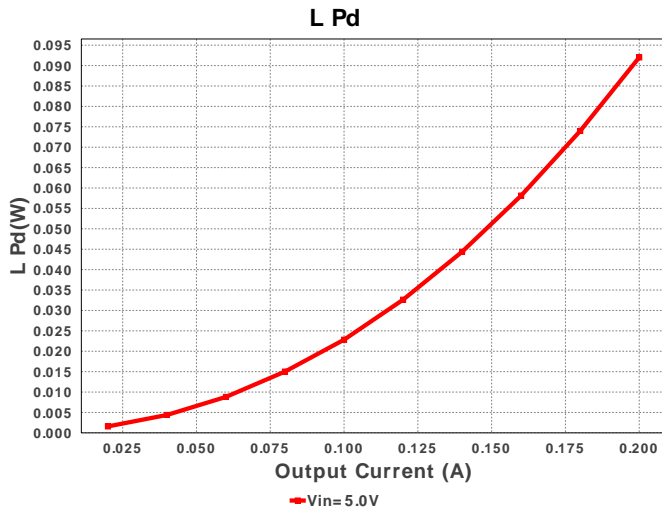
Device = LMR62014XMF/NOPB
Topology = Boost
Created = 2017-12-27 07:08:34.710
BOM Cost = \$0.85
BOM Count = 9
Total Pd = 0.34W

| # | Name | Manufacturer | Part Number | Properties | Qty | Price | Footprint |
|----|------|-------------------|------------------|------------|-----|--------|--|
| 9. | U1 | Texas Instruments | LMR62014XMF/NOPB | Switcher | 1 | \$0.55 |  DBV0005A 15 mm ² |









Operating Values

| # | Name | Value | Category | Description |
|-----|----------------|----------------------|----------|--|
| 1. | Cin IRMS | 48.757 mA | Current | Input capacitor RMS ripple current |
| 2. | Cout IRMS | 265.576 mA | Current | Output capacitor RMS ripple current |
| 3. | IC Ipk | 632.768 mA | Current | Peak switch current in IC |
| 4. | Iin Avg | 547.7 mA | Current | Average input current |
| 5. | L Ipp | 168.9 mA | Current | Peak-to-peak inductor ripple current |
| 6. | BOM Count | 9 | General | Total Design BOM count |
| 7. | FootPrint | 70.0 mm ² | General | Total Foot Print Area of BOM components |
| 8. | Frequency | 1.6 MHz | General | Switching frequency |
| 9. | Mode | CCM | General | Conduction Mode |
| 10. | Pout | 2.4 W | General | Total output power |
| 11. | Total BOM | \$0.85 | General | Total BOM Cost |
| 12. | D1 Tj | 40.301 degC | Op_Point | D1 junction temperature |
| 13. | Vout Actual | 11.824 V | Op_Point | Vout Actual calculated based on selected voltage divider resistors |
| 14. | Duty Cycle | 63.525 % | Op_point | Duty cycle |
| 15. | Efficiency | 87.64 % | Op_point | Steady state efficiency |
| 16. | IC Tj | 45.497 degC | Op_point | IC junction temperature |
| 17. | IOUT_OP | 200.0 mA | Op_point | Iout operating point |
| 18. | VIN_OP | 5.0 V | Op_point | Vin operating point |
| 19. | Vout p-p | 1.266 mV | Op_point | Peak-to-peak output ripple voltage |
| 20. | Cin Pd | 22.91 µW | Power | Input capacitor power dissipation |
| 21. | Cout Pd | 141.061 µW | Power | Output capacitor power dissipation |
| 22. | Diode Pd | 51.507 mW | Power | Diode power dissipation |
| 23. | IC Pd | 193.712 mW | Power | IC power dissipation |
| 24. | L Pd | 92.0 mW | Power | Inductor power dissipation |
| 25. | Total Pd | 338.479 mW | Power | Total Power Dissipation |
| 26. | Vout Tolerance | 3.879 % | | Vout Tolerance based on IC Tolerance (no load) and voltage divider resistors if applicable |

Design Inputs

| # | Name | Value | Description |
|----|---------|-----------|------------------------|
| 1. | Iout | 200.0 m | Maximum Output Current |
| 2. | VinMax | 5.0 | Maximum input voltage |
| 3. | VinMin | 5.0 | Minimum input voltage |
| 4. | Vout | 12.0 | Output Voltage |
| 5. | base_pn | LMR62014X | Base Product Number |
| 6. | source | DC | Input Source Type |
| 7. | Ta | 30.0 | Ambient temperature |

Design Assistance

1. **LMR62014X** Product Folder : <http://www.ti.com/product/LMR62014> : contains the data sheet and other resources.

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